

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

Preferred Device

# **General Purpose Transistor**

### **NPN Silicon**

These transistors are designed for general purpose amplifier applications. They are housed in the SOT-416/SC-75 package which is designed for low power surface mount applications.

#### Features

• Pb–Free Package is Available

#### **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ )

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	40	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	75	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	Vdc
Collector Current – Continuous	I <sub>C</sub>	600	mAdc

#### THERMAL CHARACTERISTICS

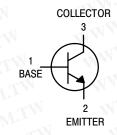
Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 1) $T_A = 25^{\circ}C$	PD	150	mW
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	833	°C/W
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

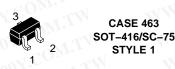
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.



#### http://onsemi.com





#### MARKING DIAGRAM



1P = Specific Device Code M = Date Code = Pb-Free Package (Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MMBT2222ATT1	SOT-416	3000 / Tape & Reel
MMBT2222ATT1G	SOT–416 (Pb–Free)	3000 / Tape & Reel

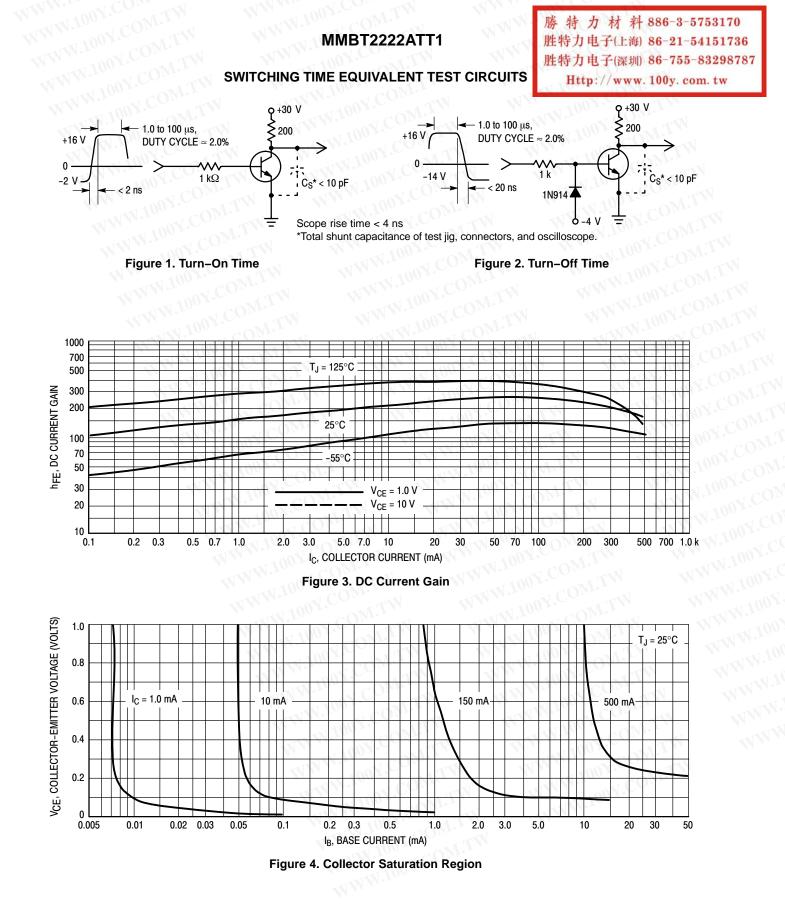
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS	MMBT2222ATT1	勝特力材料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw			
	racteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS	NWW.10 COM.	W W	NN.	N.CO	W
Collector – Emitter Breakdown Voltage ( $(I_C = 1.0 \text{ mAdc}, I_B = 0)$	Note 1)	V <sub>(BR)CEO</sub>	40	001.00	Vdc
Collector – Base Breakdown Voltage $(I_C = 10 \ \mu Adc, I_E = 0)$	NWWW.100Y.COM	V <sub>(BR)CBO</sub>	75	1002.6	Vdc
Emitter – Base Breakdown Voltage $(I_E = 10 \ \mu Adc, I_C = 0)$	WWW.LOOX.CO	V <sub>(BR)EBO</sub>	6.0	N.100	Vdc
Base Cutoff Current (V <sub>CE</sub> = 60 Vdc, V <sub>EB</sub> = 3.0 Vdc)	TW WWW.100Y.C	ON IBL	4	20	nAdc
Collector Cutoff Current (V <sub>CE</sub> = 60 Vdc, V <sub>EB</sub> = 3.0 Vdc)	ICEX	- 7	10	nAdc	
ON CHARACTERISTICS (Note 2)	TW WWW. 100	WT IN		MM.	100Y.C
$      DC Current Gain \\ (I_C = 0.1 mAdc, V_{CE} = 10 Vdc) \\ (I_C = 1.0 mAdc, V_{CE} = 10 Vdc) \\ (I_C = 10 mAdc, V_{CE} = 10 Vdc) \\ (I_C = 150 mAdc, V_{CE} = 10 Vdc) \\ (I_C = 500 mAdc, V_{CE} = 10 Vdc) \\ (I_C = 500 mAdc, V_{CE} = 10 Vdc) $	N.CONHFE MCONT MCONT	35 50 75 100 40	1 월 월 <del>3</del>	N.100X. N.100X.	
	V <sub>CE(sat)</sub>	1.14	0.3 1.0	Vdc	
Base – Emitter Saturation Voltage ( $I_C = 150$ mAdc, $I_B = 15$ mAdc) ( $I_C = 500$ mAdc, $I_B = 50$ mAdc)	V <sub>BE(sat)</sub>	0.6	1.2 2.0	Vdc	
MALL-SIGNAL CHARACTERISTICS	1002. CONCENT	W.100X.	-ON.T		
Current-Gain – Bandwidth Product (I <sub>C</sub> = 20 mAdc, V <sub>CE</sub> = 20 Vdc, f = 100	) MHz)	TT. IT	300	TW-	MHz
Output Capacitance $(V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$	W.LOOX.COM.TW	C <sub>obo</sub>	Y.COM	8.0	pF
Input Capacitance (V <sub>EB</sub> = 0.5 Vdc, $I_C$ = 0, f = 1.0 MHz)	WWW.100Y.COM.TW	C <sub>ibo</sub>	01. <u>-</u> 01.CC	30	pF
Input Impedance (V <sub>CE</sub> = 10 Vdc, $I_C$ = 10 mAdc, f = 1.0	kHz)	h <sub>ie</sub>	0.25	1.25	kΩ
Voltage Feedback Ratio ( $V_{CE}$ = 10 Vdc, $I_C$ = 10 mAdc, f = 1.0	h <sub>re</sub>	1.10 <u>0</u> X.	4.0	X 10 <sup>-4</sup>	
Small – Signal Current Gain (V <sub>CE</sub> = 10 Vdc, I <sub>C</sub> = 10 mAdc, f = 1.0	h <sub>fe</sub>	75	375	N.TW	
Output Admittance $(V_{CE} = 10 \text{ Vdc}, I_C = 10 \text{ mAdc}, f = 1.0$	h <sub>oe</sub>	25	200	μmhos	
Noise Figure ( $V_{CE}$ = 10 Vdc, $I_C$ = 100 $\mu$ Adc, $R_S$ = 7	NF	NN-N.	4.0	dB	
SWITCHING CHARACTERISTICS	WWW.100Y.COM	WT	MM		
Delay Time	Delay Time $(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc}, I_{CC} = 150 \text{ mAdc})$			10	ne
B: T	NJ- 1		0.5	ns	

Delay Time	$(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc},$	t <sub>d</sub>	-	10	20
Rise Time	I <sub>C</sub> = 150 mAdc, I <sub>B1</sub> = 15 mAdc)	t <sub>r</sub>	-	25	ns
Storage Time	$(V_{CC} = 30 \text{ Vdc}, I_C = 150 \text{ mAdc},$	ts	-	225	ns
Fall Time	$I_{B1} = I_{B2} = 15 \text{ mAdc}$ )	t <sub>f</sub>	-	60	113

1. Device mounted on FR4 glass epoxy printed circuit board using the minimum recommended footprint.2. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.



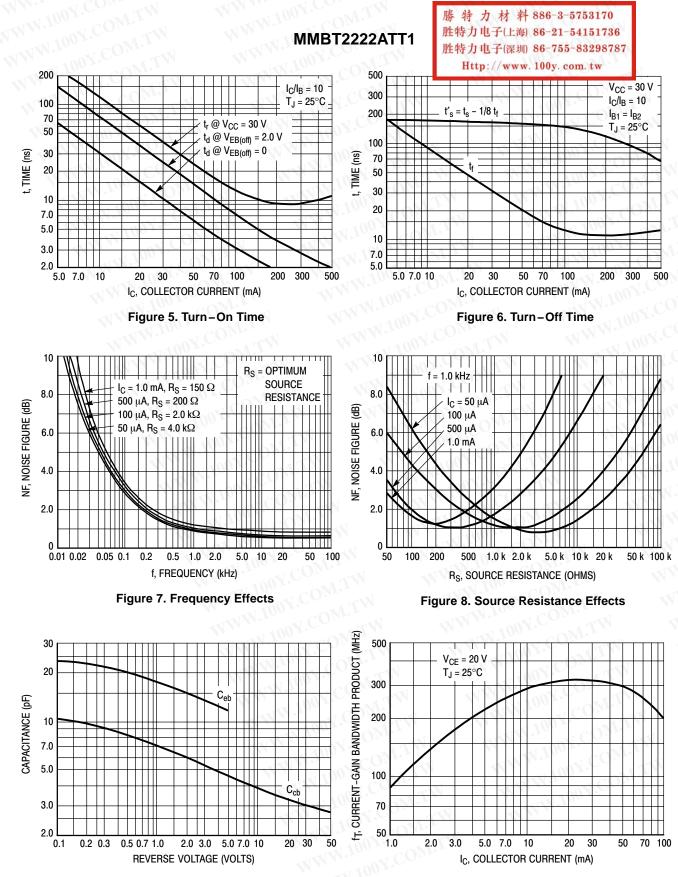
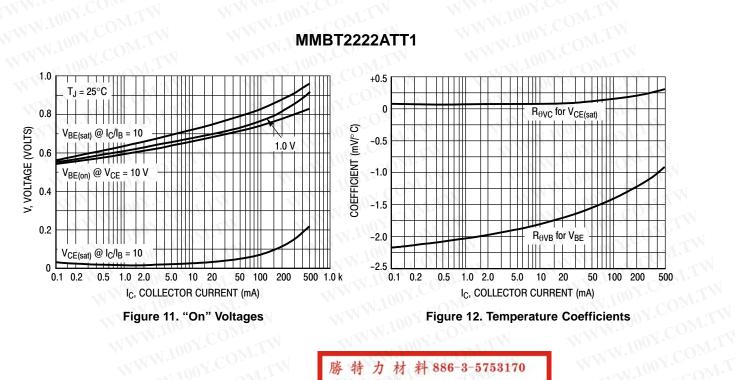




Figure 10. Current–Gain Bandwidth Product

## WWW.100Y.C MMBT2222ATT1





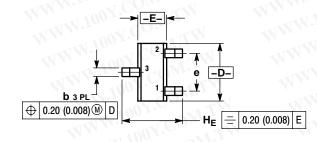
# WWW.100Y.COM.TW

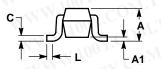
特力材料 886-3-5753170 勝 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

#### MMBT2222ATT1

#### PACKAGE DIMENSIONS

SC-75/SOT-416 CASE 463-01 ISSUE F





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.

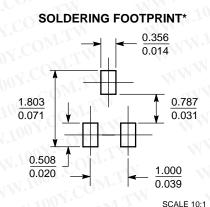
1	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.70	0.80	0.90	0.027	0.031	0.035	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
b	0.15	0.20	0.30	0.006	0.008	0.012	
С	0.10	0.15	0.25	0.004	0.006	0.010	
D	1.55	1.60	1.65	0.059	0.063	0.067	
E	0.70	0.80	0.90	0.027	0.031	0.035	
е	1.00 BSC			C	.04 BSC	)	
Ľ.	0.10	0.15	0.20	0.004	0.006	0.008	
H <sub>E</sub>	1.50	1.60	1.70	0.061	0.063	0.065	

STYLE 1: PIN 1. BASE

mm

inches

2. EMITTER 3. COLLECTOR



勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and use registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other application is unich the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use personal and seleging out of, directly or indirectly, any claim of personal injury or death agolication as negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 61312, Phoenix, Arizona 85082–1312 USA Phone: 480–829–7710 or 800–344–3860 Toll Free USA/Canada Fax: 480–829–7709 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800–282–9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center 2–9–1 Kamimeguro, Meguro–ku, Tokyo, Japan 153–0051 Phone: 81–3–5773–3850 ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.

MMBT2222ATT1/D